



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

TALIEH et al.

Serial No.: 09/941,360

Filed: August 28, 2001

Title: Method And Apparatus For Plating and  
Polishing A Semiconductor Substrate

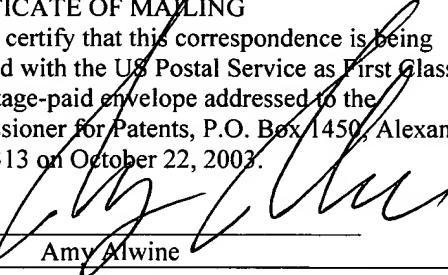
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Group Art Unit: 1742  
Examiner: D. Valentine  
Docket: NT-004D-US

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being  
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in a postage-paid envelope addressed to the  
Commissioner for Patents, P.O. Box 1450, Alexandria,  
VA 22313 on October 22, 2003.

Signed:

  
Amy Alwine

**AMENDMENT A**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313

Dear Sir:

In response to the Office Action mailed July 2, 2003, Applicants petition for a one-month extension to the shortened statutory period response and asserts small entity status in an accompanying paper. A PTO-2038 form for \$55 is included to cover the one-month extension fee. Applicants request entry and consideration of the following Remarks and Amendment. Please amend the above-identified application as follows:

**Amendments to the Specification** begin on page 2 of this paper.

**Amendments to the Claims** are reflected in the listing of claims which begins on page 3 of this paper.

**Remarks/Arguments** begin on page 5 of this paper.